

REV.	ECN NO.	MODIFY	MATTER	DATE	APPROVED
A			RELEASE TO PRODUCTION		

NOTE:

1. MATERIALS:

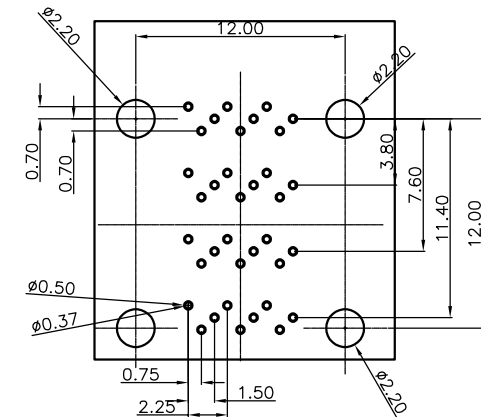
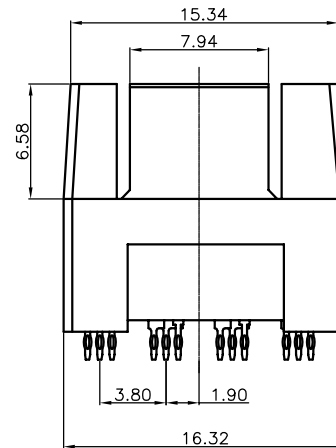
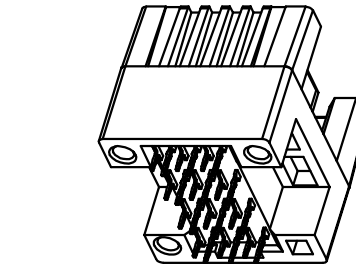
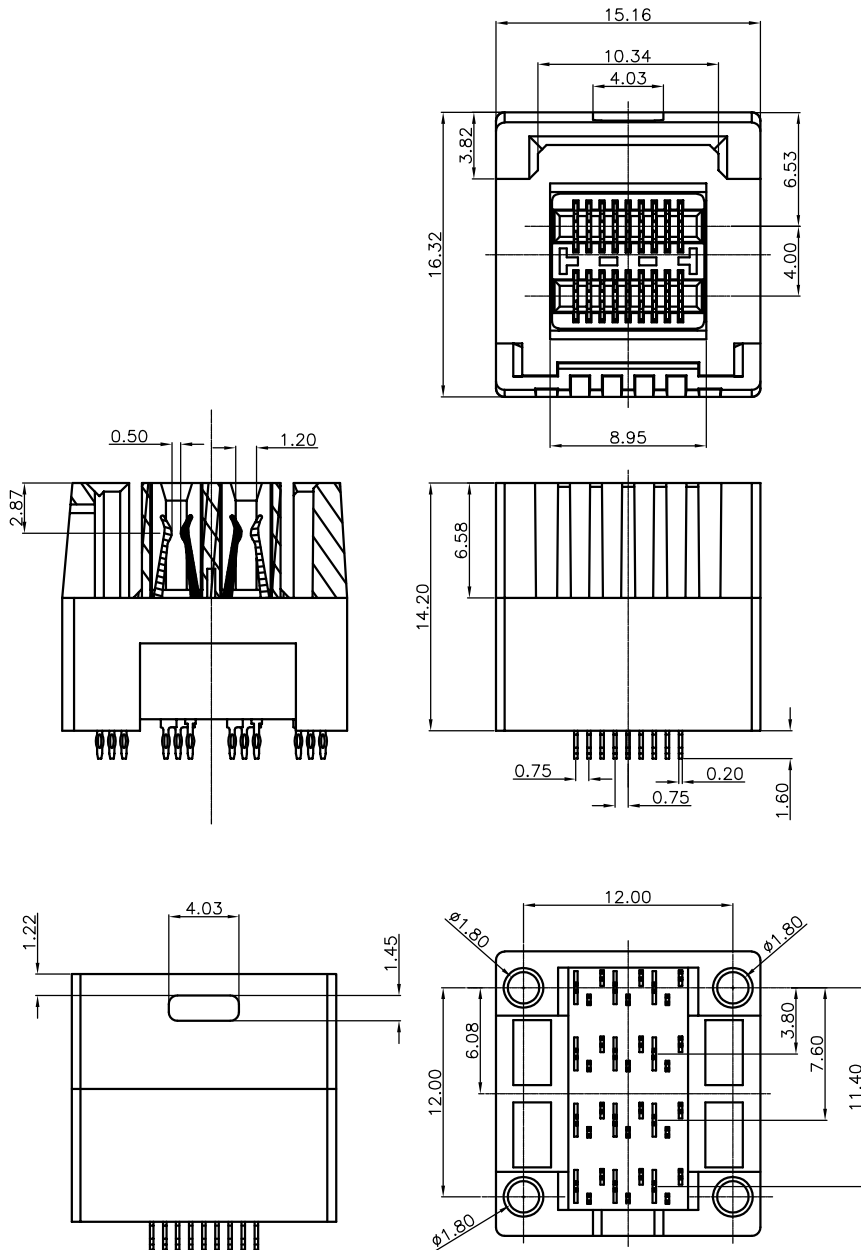
HOUSING:LCP+30%GF, UL94V-0 BLACK

CONTACTS:COPPER ALLOY

NI UNDER PLATING OVER ALL, THICKNESS:50u"~150u",

MATTE TIN OVER NI ON SOLDER AREA, THICKNESS:30u"~80u",

GOLD PLATING OVER NI ON CONTACT AREA, THICKNESS:15U"



PCB LAYOUT

EAST-MSAS8643B1GR

Plating: _____

A-Flash.Gold on contact area;
 B-3u" Gold on contact area;
 C-5u" Gold on contact area;
 D-10u" Gold on contact area;
 E-15u" Gold on contact area;
 G-30u" Gold on contact area;

TOLERANCES UNLESS OTHERWISE SPECIFIED: X. --- X.X ± 0.38 X.XX ± 0.25 X.XXX ± 0.20 Angle ± 3°		COSTOMER COPY		深圳市东方御业科技有限公司 www.dfyyconn.com TEL:0755-27155560	
DRAWN: Qinkx		2017/09/10		TITAL: MINI SAS HD 4X VT	
CHECKED: Chenl		2017/09/10		PART NO: EAST-MSAS8643B1AR	
APPROVED: Chenl		2017/09/10		UNIT: mm	
THESE DRAWING AND SPECIFICATION ARE THE PROPERTY OF Shenzhen Dongfangyue ELECTRONIC CO., LTD.. SHALL NOT BE REPRODUCED.		SCALE: N/A		SHEEL: 1/1	
				REV. A	